

1/2

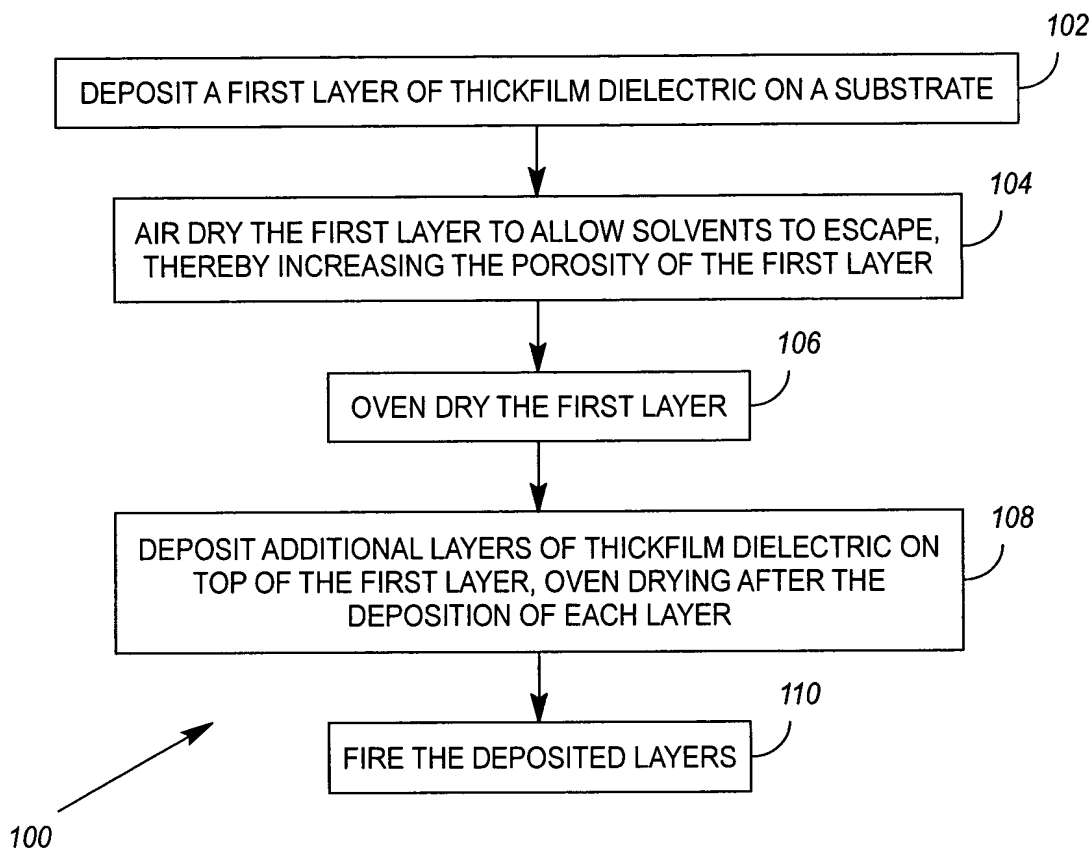
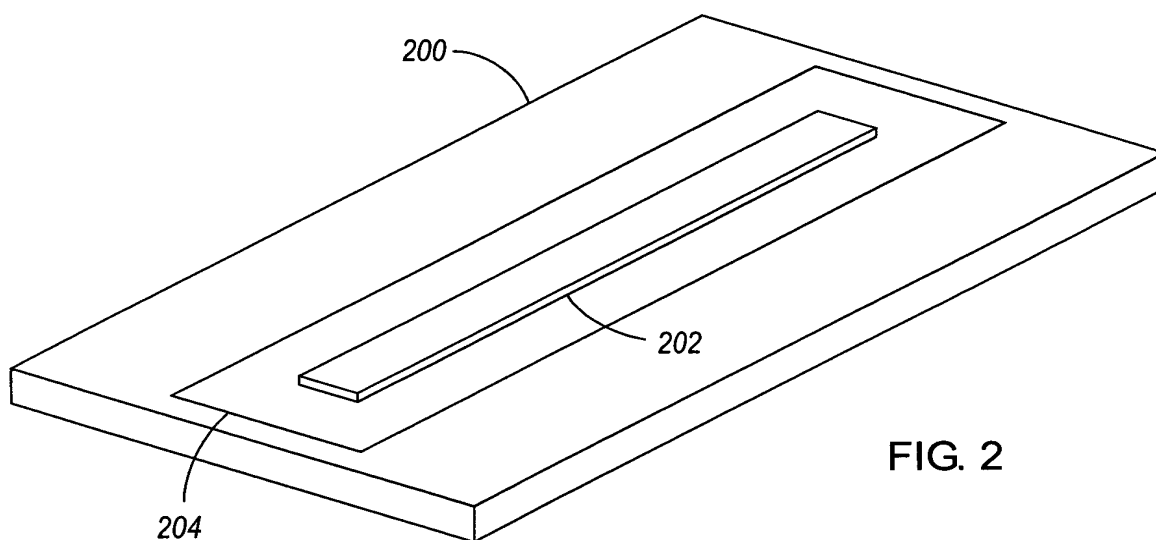


FIG. 1



"METHODS FOR DEPOSITING A THICKFILM DIELECTRIC ON A SUBSTRATE"

Inventors - John F. Casey, et al.

Docket No. - 10030747-1

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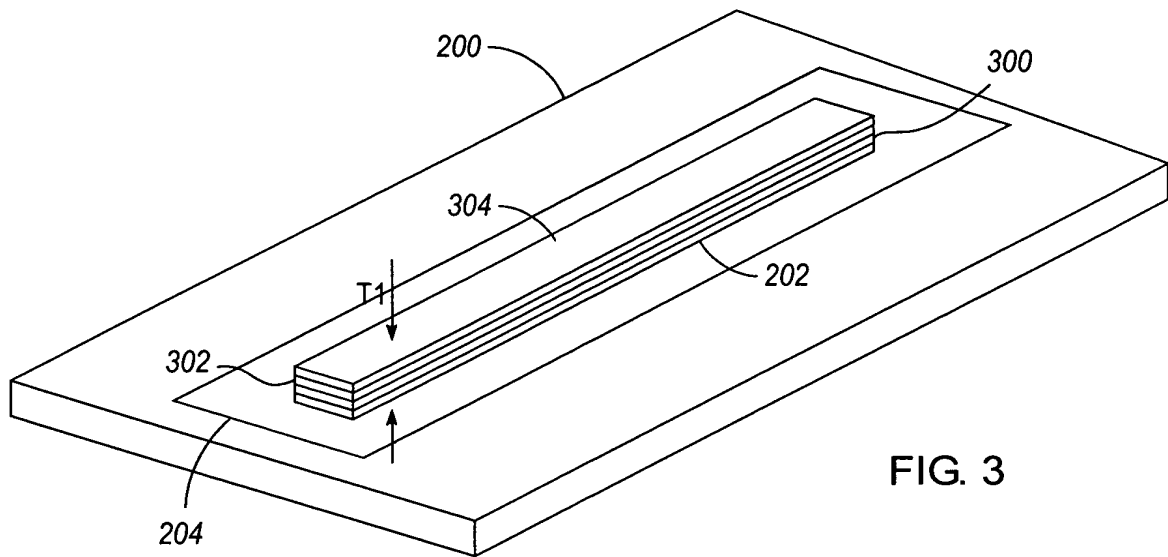


FIG. 3

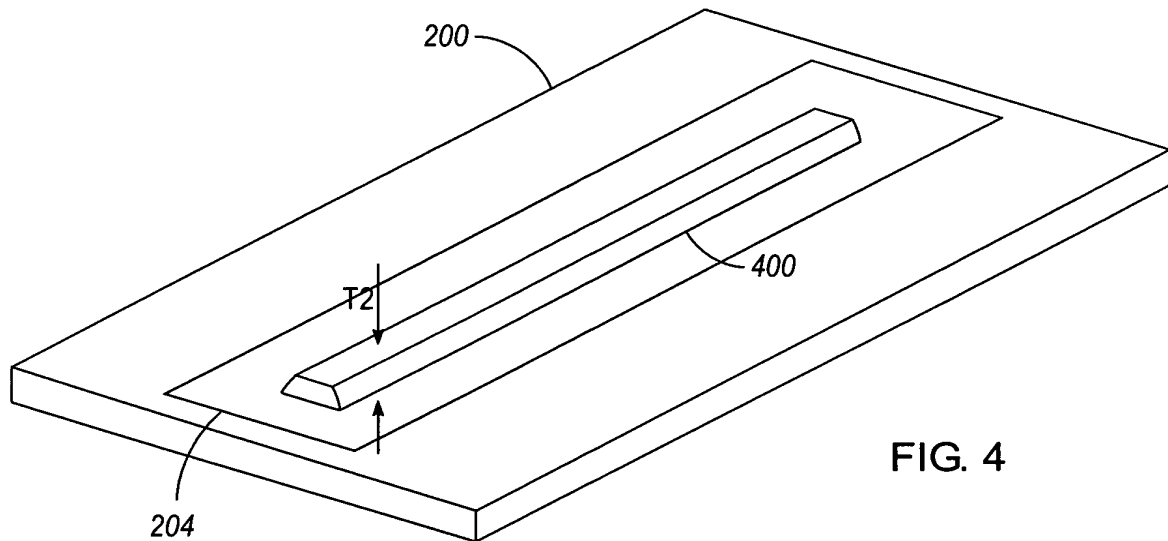


FIG. 4

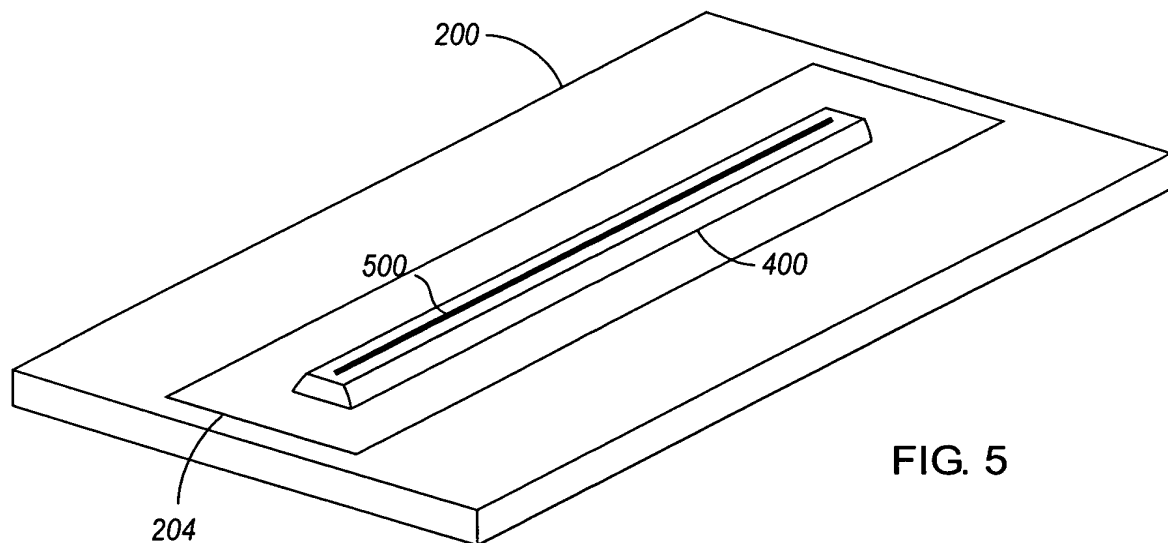


FIG. 5